## **AMENDMENTS TO CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application:

## **Listing of Claims:**

- 1. (Currently Amended) A deep trench structure of semiconductor device, said semiconductor device having a plurality of active areas, said deep trench structure characterized in that said having a deep trench communicates communicating with two different active areas which are respectively connected to two adjacent bit lines.
- 2. (Currently Amended) The structure as claimed in Claim 1, wherein the cross section of said deep trench communicates with <u>said</u> two different active areas.
- 3. (Canceled)
- 4. (Currently Amended) A semiconductor memory device comprising:
  - a plurality of bit lines;
  - a plurality of gates crossing intersecting with said bit lines;
  - a plurality of active areas, each of which is connected to one of said bit lines;
- a plurality of deep trenches, at least one of which communicates with two different active areas which are respectively connected with adjacent two of said bit lines.
- 5. (Currently Amended) The device as claimed in Claim 4, wherein the cross section of said deep trench communicates with <u>said</u> two different active areas.
- 6. (Canceled)